# onsemi

# Micropower Undervoltage Sensing Circuits

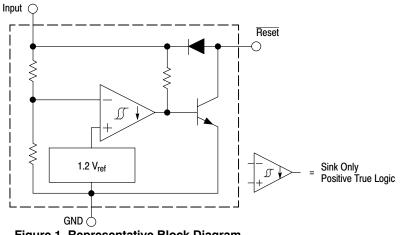
# MC34164, MC33164, NCV33164

The MC34164 series are undervoltage sensing circuits specifically designed for use as reset controllers in portable microprocessor based systems where extended battery life is required. These devices offer the designer an economical solution for low voltage detection with a single external resistor. The MC34164 series features a bandgap reference, a comparator with precise thresholds and built–in hysteresis to prevent erratic reset operation, an open collector reset output capable of sinking in excess of 6.0 mA, and guaranteed operation down to 1.0 V input with extremely low standby current. The MC devices are packaged in 3–pin TO–92 (TO–226AA), micro size TSOP–5, 8–pin SOIC–8 and Micro8 surface mount packages. The NCV device is packaged in SOIC–8.

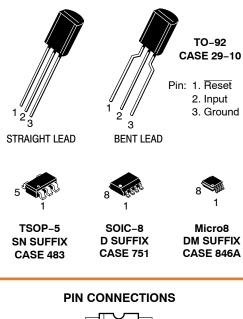
Applications include direct monitoring of the 3.0 V or 5.0 V MPU/logic power supply used in appliance, automotive, consumer, and industrial equipment.

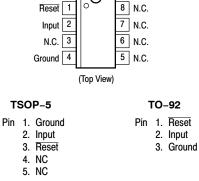
# Features

- Temperature Compensated Reference
- Monitors 3.0 V (MC34164-3) or 5.0 V (MC34164-5) Power Supplies
- Precise Comparator Thresholds Guaranteed Over Temperature
- Comparator Hysteresis Prevents Erratic Reset
- Reset Output Capable of Sinking in Excess of 6.0 mA
- Internal Clamp Diode for Discharging Delay Capacitor
- Guaranteed Reset Operation With 1.0 V Input
- Extremely Low Standby Current: As Low as 9.0 µA
- Economical TO-92 (TO-226AA), TSOP-5, SOIC-8 and Micro8 Surface Mount Packages
- NCV Prefix for Automotive and Other Applications Requiring Site and Control Changes
- These Devices are Pb–Free and are RoHS Compliant









## **ORDERING INFORMATION**

See detailed ordering and shipping information on page 7 of this data sheet.

#### **DEVICE MARKING INFORMATION**

See general marking information in the device marking section on page 8 of this data sheet.

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Power Input Supply Voltage	V <sub>in</sub>	-1.0 to 12	V
Reset Output Voltage	Vo	-1.0 to 12	V
Reset Output Sink Current	I <sub>Sink</sub>	Internally Limited	mA
Clamp Diode Forward Current, Reset to Input Pin (Note 1)	IF	100	mA
Power Dissipation and Thermal Characteristics P Suffix, Plastic Package Maximum Power Dissipation @ $T_A = 25^{\circ}C$ Thermal Resistance, Junction-to-Air D Suffix, Plastic Package Maximum Power Dissipation @ $T_A = 25^{\circ}C$ Thermal Resistance, Junction-to-Air DM Suffix, Plastic Package Maximum Power Dissipation @ $T_A = 25^{\circ}C$ Thermal Resistance, Junction-to-Air	Ρ <sub>D</sub> R <sub>θJA</sub> Ρ <sub>D</sub> R <sub>θJA</sub> Ρ <sub>D</sub> R <sub>θJA</sub>	700 178 700 178 520 240	mW °C/W °C/W mW °C/W
Operating Junction Temperature	TJ	+150	°C
Operating Ambient Temperature Range MC34164 Series MC33164 Series, NCV33164	T <sub>A</sub>	0 to +70 - 40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	– 65 to +150	°C
Electrostatic Discharge Sensitivity (ESD) Human Body Model (HBM) Machine Model (MM)	ESD	4000 200	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### MC34164-3, MC33164-3 SERIES, NCV33164-3

**ELECTRICAL CHARACTERISTICS** (For typical values  $T_A = 25^{\circ}C$ , for min/max values  $T_A$  is the operating ambient temperature range that applies [Notes 2 & 3], unless otherwise noted.)

Symbol	Min	Тур	Мах	Unit
V <sub>IH</sub> V <sub>IL</sub> V <sub>H</sub>	2.55 2.55 0.03	2.71 2.65 0.06	2.80 2.80 -	V
V <sub>OL</sub>	-	0.14 0.1	0.4 0.3	V
I <sub>Sink</sub>	6.0	12	30	mA
<sup>I</sup> R(leak)	-	0.02 0.02	0.5 1.0	μΑ
V <sub>F</sub>	0.6	0.9	1.2	V
	V <sub>IH</sub> V <sub>IL</sub> V <sub>H</sub> V <sub>OL</sub> I <sub>Sink</sub> <sup>I</sup> R(leak)	V <sub>IH</sub> 2.55 V <sub>IL</sub> 2.55 V <sub>H</sub> 0.03	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{tabular}{ c c c c c c c } \hline V_{IH} & 2.55 & 2.71 & 2.80 \\ V_{IL} & 2.55 & 2.65 & 2.80 \\ V_{H} & 0.03 & 0.06 & - \end{tabular} \\ \hline \hline V_{OL} & & & & & & \\ \hline & & & & & & & & \\ \hline & & & &$

TOTAL DEVICE

Operating Input Voltage Range	V <sub>in</sub>	1.0 to 10	-	-	V
Quiescent Input Current $V_{in} = 3.0 V$ $V_{in} = 6.0 V$	l <sub>in</sub>	-	9.0 24	15 40	μΑ

1. Maximum package power dissipation limits must be observed.

2. Low duty cycle pulse techniques are used during test to maintain junction temperature as close to ambient as possible. 3.  $T_{low} = 0^{\circ}$ C for MC34164  $T_{high} = +70^{\circ}$ C for MC34164

= - 40°C for MC33164, NCV33164 = +125°C for MC33164, NCV33164

#### MC34164-5, MC33164-5 SERIES, NCV33164-5

**ELECTRICAL CHARACTERISTICS** (For typical values  $T_A = 25^{\circ}C$ , for min/max values  $T_A$  is the operating ambient temperature range that applies [Notes 5 & 6], unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit
COMPARATOR					-
Threshold Voltage High State Output (V <sub>in</sub> Increasing)	V <sub>IH</sub>	4.15	4.33	4.45	V
Low State Output (V <sub>in</sub> Decreasing) Hysteresis (I <sub>Sink</sub> = 100 μΑ)	V <sub>IL</sub> V <sub>H</sub>	4.15 0.02	4.27 0.09	4.45 -	
RESET OUTPUT					
Output Sink Saturation ( $V_{in} = 4.0 \text{ V}, I_{Sink} = 1.0 \text{ mA}$ ) ( $V_{in} = 1.0 \text{ V}, I_{Sink} = 0.25 \text{ mA}$ )	V <sub>OL</sub>		0.14 0.1	0.4 0.3	V
Output Sink Current (V <sub>in</sub> , Reset = 4.0 V)	I <sub>Sink</sub>	7.0	20	50	mA
Output Off-State Leakage (V <sub>in</sub> , Reset = 5.0 V) (V <sub>in</sub> , Reset = 10 V)	<sup>I</sup> R(leak)		0.02 0.02	0.5 2.0	μΑ
Clamp Diode Forward Voltage, Reset to Input Pin ( $I_F = 5.0 \text{ mA}$ )	V <sub>F</sub>	0.6	0.9	1.2	V
TOTAL DEVICE	•	•		•	•
Operating Input Voltage Range	V <sub>in</sub>	1.0 to 10	-	-	V

 $I_{in}$ 

4. Maximum package power dissipation limits must be observed.

**Quiescent Input Current** 

. V<sub>in</sub> = 5.0 V

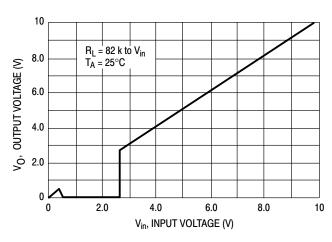
V<sub>in</sub> = 10 V

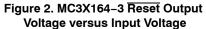
5. Low duty cycle pulse techniques are used during test to maintain junction temperature as close to ambient as possible.

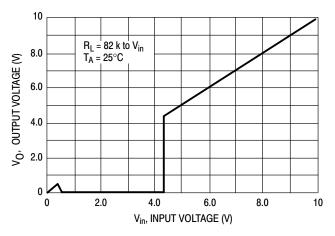
6.  $T_{low} = 0^{\circ}$ C for MC34164  $T_{high} = +70^{\circ}$ C for MC34164

= - 40°C for MC33164, NCV33164 = +125°C for MC33164, NCV33164

7. NCV prefix is for automotive and other applications requiring site and change control.







12

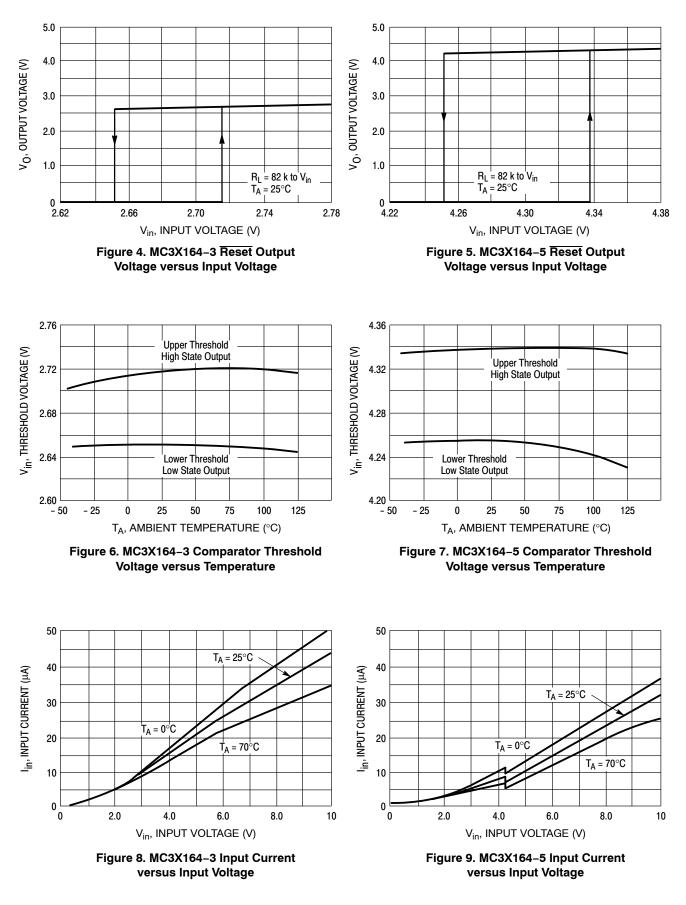
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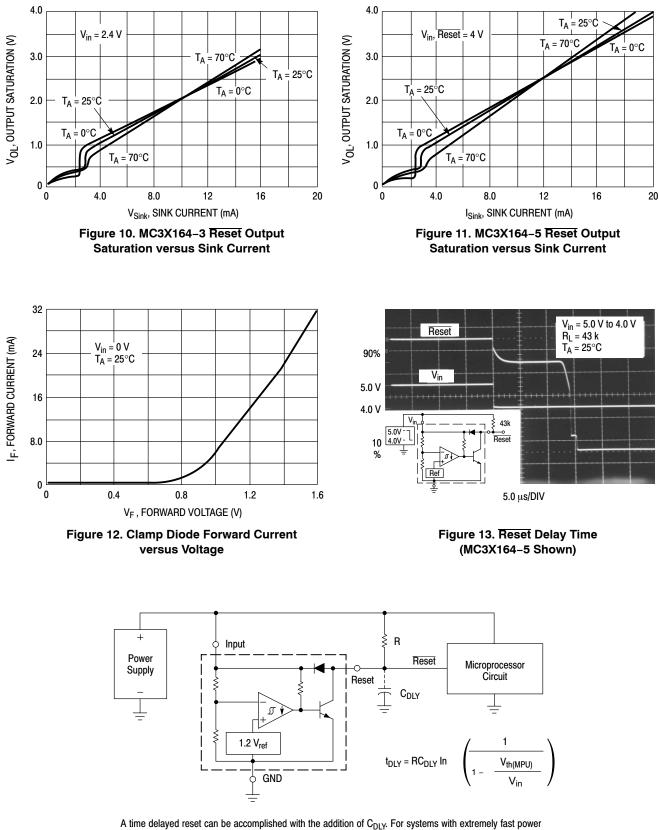
μA

20

50

Figure 3. MC3X164–5 Reset Output Voltage versus Input Voltage

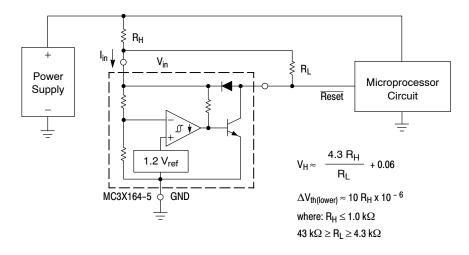




supply rise times (< 500 ns) it is recommended that the RC<sub>DLY</sub> time constant be greater than 5.0  $\mu$ s. V<sub>th(MPU)</sub> is the microprocessor reset input threshold.

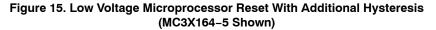
#### Figure 14. Low Voltage Microprocessor Reset





	Test Data				
V <sub>H</sub> (mV)	∆V <sub>th</sub> (mV)	<b>R<sub>H</sub></b> (Ω)	R <sub>L</sub> (kΩ)		
60	0	0	43		
103	1.0	100	10		
123	1.0	100	6.8		
160	1.0	100	4.3		
155	2.2	220	10		
199	2.2	220	6.8		
280	2.2	220	4.3		
262	4.7	470	10		
306	4.7	470	8.2		
357	4.7	470	6.8		
421	4.7	470	5.6		
530	4.7	470	4.3		

Comparator hysteresis can be increased with the addition of resistor R<sub>H</sub>. The hysteresis equation has been simplified and does not account for the change of input current  $I_{in}$  as  $V_{in}$  crosses the comparator threshold (Figure 8). An increase of the lower threshold  $\Delta V_{th(lower)}$  will be observed due to  $I_{in}$  which is typically 10  $\mu$ A at 4.3 V. The equations are accurate to  $\pm$ 10% with R<sub>H</sub> less than 1.0 k $\Omega$  and R<sub>L</sub> between 4.3 k $\Omega$  and 43 k $\Omega$ .



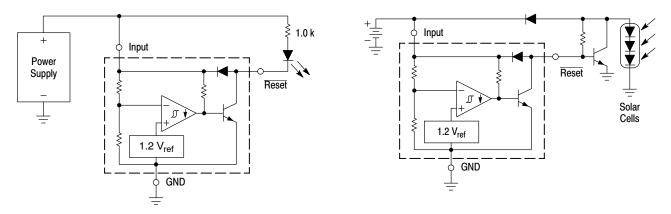


Figure 16. Voltage Monitor



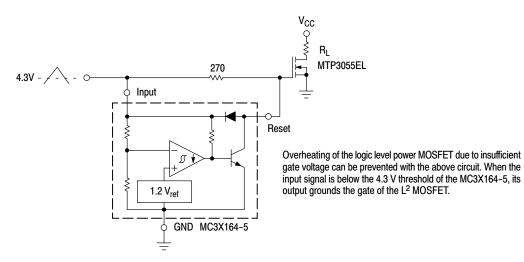


Figure 18. MOSFET Low Voltage Gate Drive Protection Using the MC3X164-5

### **ORDERING INFORMATION**

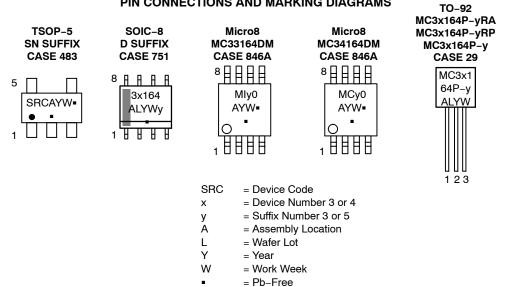
Device	Package	Shipping <sup>†</sup>
MC33164D-3G	SOIC-8 (Pb-Free)	98 Units / Rail
MC33164D-3R2G	SOIC-8 (Pb-Free)	0500 Heite / Tana & Daal
NCV33164D-3R2G*	SOIC-8 (Pb-Free)	2500 Units / Tape & Reel
MC33164DM-3R2G	Micro8 (Pb–Free)	4000 Units / Tape & Reel
MC33164P-3G	TO–92 (Pb–Free)	2000 Units / Box
MC33164P-3RAG	TO–92 (Pb–Free)	2000 Units / Tape & Reel
MC33164P-3RPG	TO–92 (Pb–Free)	2000 Units / Pack
MC33164D-5G	SOIC-8 (Pb-Free)	98 Units / Rail
MC33164D-5R2G	SOIC-8 (Pb-Free)	
NCV33164D-5R2G*	SOIC-8 (Pb-Free)	2500 Units / Tape & Reel
MC33164DM-5R2G	Micro8 (Pb–Free)	4000 Units / Tape & Reel
MC33164P-5G	TO-92 (Pb-Free)	2000 Units / Box
MC33164P-5RAG	TO-92 (Pb-Free)	2000 Units / Tape & Reel
MC33164P-5RPG	TO-92 (Pb-Free)	2000 Units / Pack
MC34164D-3G	SOIC-8 (Pb-Free)	98 Units / Rail
MC34164D-3R2G	SOIC-8 (Pb-Free)	2500 Units / Tape & Reel
MC34164DM-3R2G	Micro8 (Pb–Free)	4000 Units / Tape & Reel
MC34164P-3G	TO-92 (Pb-Free)	2000 Units / Box
MC34164P-3RPG	TO-92 (Pb-Free)	2000 Units / Pack
MC34164D-5G	SOIC-8 (Pb-Free)	98 Units / Rail
MC34164D-5R2G	SOIC-8 (Pb-Free)	2500 Units / Tape & Reel
MC34164DM-5R2G	Micro8 (Pb–Free)	4000 Units / Tape & Reel
MC34164SN-5T1G	TSOP-5 (Pb-Free)	3000 Units / Tape & Reel
MC34164P-5G	TO-92 (Pb-Free)	2000 Units / Box
MC34164P-5RAG	TO-92 (Pb-Free)	2000 Units / Tape & Reel
MC34164P-5RPG	TO-92 (Pb-Free)	2000 Units / Pack

\*NCV33164:  $T_{low} = -40^{\circ}C$ ,  $T_{high} = +125^{\circ}C$ . Guaranteed by design. NCV prefix is for automotive and other applications requiring site and change control.

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

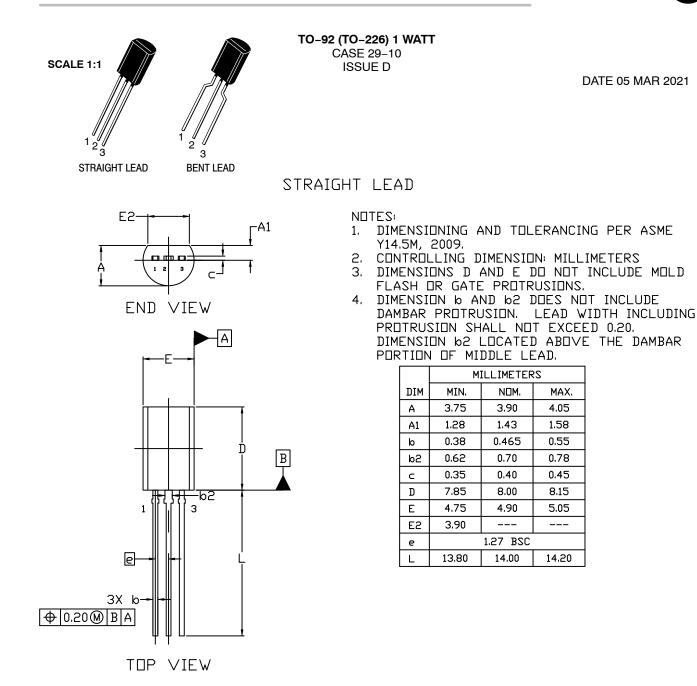
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## PIN CONNECTIONS AND MARKING DIAGRAMS



# MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





# **STYLES AND MARKING ON PAGE 3**

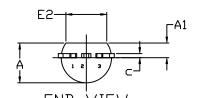
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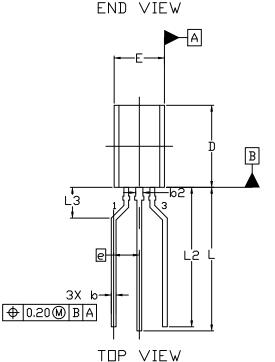


#### TO-92 (TO-226) 1 WATT CASE 29-10 ISSUE D

DATE 05 MAR 2021

FORMED LEAD





# NDTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS.
- 4. DIMENSION № AND №2 DOES NOT INCLUDE DAMBAR PROTRUSION. LEAD WIDTH INCLUDING PROTRUSION SHALL NOT EXCEED 0.20. DIMENSION №2 LOCATED ABOVE THE DAMBAR PORTION OF MIDDLE LEAD.

	м	ILLIMETER	28
DIM	MIN.	NDM.	MAX.
Α	3.75	3.90	4.05
A1	1.28	1.43	1.58
b	0.38	0.465	0.55
b2	0.62	0.70	0.78
с	0.35	0.40	0.45
D	7.85	8.00	8.15
Е	4.75	4.90	5.05
E2	3.90		
e	2.50 BSC		
L	13.80	14.00	14.20
L2	13.20	13.60	14.00
L3		3.00 REF	

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#### TO-92 (TO-226) 1 WATT CASE 29-10 ISSUE D

### DATE 05 MAR 2021

STYLE 5: PIN 1. DRAIN

2.	EMITTER BASE COLLECTOR
	GATE SOURCE & SUBSTRATE DRAIN
2.	ANODE CATHODE & ANODE CATHODE
2.	ANODE GATE CATHODE
2.	COLLECTOR EMITTER BASE
	V <sub>CC</sub> GROUND 2 OUTPUT

	BASE EMITTER COLLECTOR
2.	SOURCE DRAIN GATE
2.	MAIN TERMINAL 1 Gate Main Terminal 2
2.	COLLECTOR BASE EMITTER
2.	Source Gate Drain
STYLE 27: PIN 1. 2. 3.	

2.	ANODE ANODE CATHODE
2.	DRAIN GATE SOURCE & SUBSTRATE
2.	ANODE 1 GATE CATHODE 2
2.	ANODE CATHODE NOT CONNECTED
	GATE SOURCE DRAIN
2.	CATHODE ANODE GATE
2.	RETURN INPUT OUTPUT

STYLE 4: PIN 1. CATHODE 2. CATHODE 3. ANODE STYLE 9: PIN 1. BASE 1 2. EMITTER 3. BASE 2 STYLE 14: PIN 1. EMITTER 2. COLLECTOR 3. BASE STYLE 19: PIN 1. GATE 2. ANODE 3. CATHODE STYLE 24: PIN 1. EMITTER 2. COLLECTOR/ANODE 3. CATHODE STYLE 29: PIN 1. NOT CONNECTED 2. ANODE 3. CATHODE STYLE 34: PIN 1. INPUT

2. GROUND 3. LOGIC

2. SOURCE 3. GATE STYLE 10: PIN 1. CATHODE 2. GATE 3. ANODE STYLE 15: PIN 1. ANODE 1 2. CATHODE 3. ANODE 2 STYLE 20: PIN 1. NOT CONNECTED 2. CATHODE 3. ANODE STYLE 25: PIN 1. MT 1 2. GATE 3. MT 2 STYLE 30: PIN 1. DRAIN 2. GATE 3. SOURCE STYLE 35: PIN 1. GATE 2. COLLECTOR 3. EMITTER

### GENERIC MARKING DIAGRAM\*

XXXXX XXXXX ALYW

XXXX = Specific Device Code

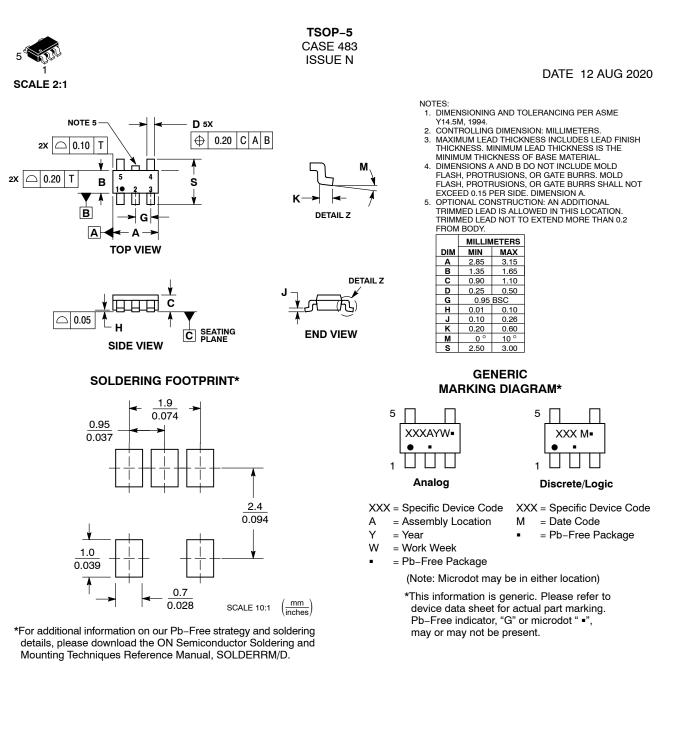
- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week
  - = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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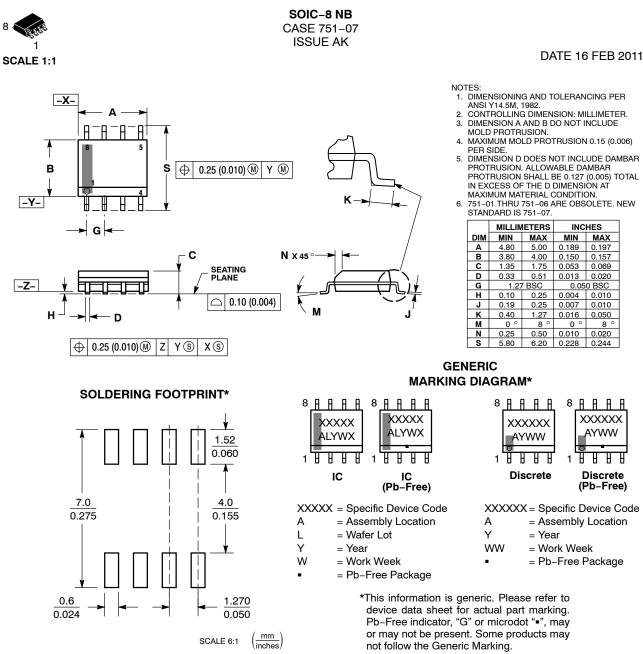




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# DURSEM



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# **STYLES ON PAGE 2**

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#### SOIC-8 NB CASE 751-07 **ISSUE AK**

STYLE 1: PIN 1. EMITTER COLLECTOR 2. COLLECTOR 3. 4. EMITTER EMITTER 5. BASE 6. 7 BASE EMITTER 8. STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN DRAIN 4. GATE 5. 6. GATE SOURCE 7. 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON COLLECTOR, DIE #1 COLLECTOR, DIE #2 2. З. EMITTER, COMMON 4. 5. EMITTER, COMMON 6 BASE. DIE #2 BASE, DIE #1 7. 8. EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3 GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. DRAIN 8. STYLE 17: PIN 1. VCC 2. V2OUT V10UT З. TXE 4. 5. RXE 6. VFF 7. GND 8. ACC STYLE 21: CATHODE 1 PIN 1. 2. CATHODE 2 3 CATHODE 3 CATHODE 4 4. 5. CATHODE 5 6. COMMON ANODE COMMON ANODE 7. 8. CATHODE 6 STYLE 25: PIN 1. VIN 2 N/C REXT З. 4. GND 5. IOUT 6. IOUT IOUT 7. 8. IOUT STYLE 29: BASE, DIE #1 PIN 1. 2 EMITTER, #1 BASE, #2 З. EMITTER, #2 4. 5 COLLECTOR, #2 COLLECTOR, #2 6.

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 COLLECTOR, #2 3. 4 COLLECTOR, #2 BASE, #2 5. EMITTER, #2 6. 7 BASE #1 EMITTER, #1 8. STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN SOURCE 4. SOURCE 5. 6. GATE GATE 7. 8. SOURCE STYLE 10: GROUND PIN 1. BIAS 1 OUTPUT 2. З. GROUND 4. 5. GROUND 6 BIAS 2 INPUT 7. 8. GROUND STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3 P-SOURCE P-GATE 4. P-DRAIN 5 6. P-DRAIN N-DRAIN 7. N-DRAIN 8. STYLE 18: PIN 1. ANODE ANODE 2. SOURCE 3. GATE 4. 5. DRAIN 6 DRAIN CATHODE 7. CATHODE 8. STYLE 22 PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC COMMON CATHODE/VCC 3 4. I/O LINE 3 COMMON ANODE/GND 5. 6. I/O LINE 4 7. I/O LINE 5 COMMON ANODE/GND 8. STYLE 26: PIN 1. GND 2 dv/dt З. ENABLE 4. ILIMIT 5. SOURCE SOURCE 6. SOURCE 7. 8. VCC STYLE 30: DRAIN 1 PIN 1. DRAIN 1 2 GATE 2 З. SOURCE 2 4 SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2 5.

6.

7.

8 GATE 1

SOURCE 1/DRAIN 2

STYLE 3: DRAIN, DIE #1 PIN 1. DRAIN, #1 2. DRAIN, #2 З. DRAIN, #2 4. GATE, #2 5. SOURCE, #2 6. 7 GATE #1 8. SOURCE, #1 STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS THIRD STAGE SOURCE GROUND З. 4. 5. DRAIN 6. GATE 3 SECOND STAGE Vd 7. FIRST STAGE Vd 8. STYLE 11: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. DRAIN 2 DRAIN 1 7. 8. DRAIN 1 STYLE 15: PIN 1. ANODE 1 2. ANODE 1 ANODE 1 3 ANODE 1 4. 5. CATHODE, COMMON CATHODE, COMMON CATHODE, COMMON 6. 7. CATHODE, COMMON 8. STYLE 19: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 MIRROR 1 8. STYLE 23: PIN 1. LINE 1 IN COMMON ANODE/GND COMMON ANODE/GND 2. 3 LINE 2 IN 4. LINE 2 OUT 5. COMMON ANODE/GND COMMON ANODE/GND 6. 7. 8. LINE 1 OUT STYLE 27: PIN 1. ILIMIT 2 OVI 0 UVLO З. 4. INPUT+ 5. 6. SOURCE SOURCE SOURCE 7. 8 DRAIN

#### DATE 16 FEB 2011

STYLE 4: PIN 1. 2. ANODE ANODE ANODE З. 4. ANODE ANODE 5. 6. ANODE 7 ANODE COMMON CATHODE 8. STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 BASE #2 З. COLLECTOR, #2 4. COLLECTOR, #2 5. 6. EMITTER, #2 EMITTER, #1 7. 8. COLLECTOR, #1 STYLE 12: PIN 1. SOURCE SOURCE 2. 3. GATE 4. 5. DRAIN 6 DRAIN DRAIN 7. 8. DRAIN STYLE 16 EMITTER, DIE #1 PIN 1. 2. BASE, DIE #1 EMITTER, DIE #2 3 BASE, DIE #2 4. 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 COLLECTOR, DIE #1 7. COLLECTOR, DIE #1 8. STYLE 20: PIN 1. SOURCE (N) GATE (N) SOURCE (P) 2. 3. 4. GATE (P) 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 24: PIN 1. BASE EMITTER 2. 3 COLLECTOR/ANODE COLLECTOR/ANODE 4. 5. CATHODE 6. CATHODE COLLECTOR/ANODE 7. 8. COLLECTOR/ANODE STYLE 28: PIN 1. SW\_TO\_GND 2. DASIC OFF DASIC\_SW\_DET З. 4. GND 5. 6. V MON VBULK 7. VBULK 8 VIN

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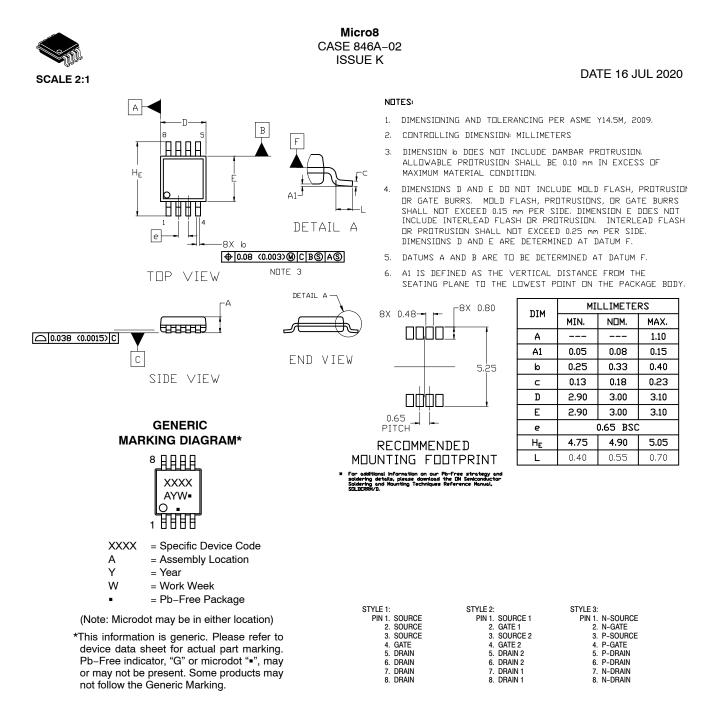
7.

8

COLLECTOR, #1

COLLECTOR, #1





 
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